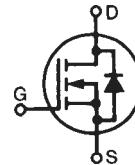


PolarHT™ Power MOSFET

N-Channel Enhancement Mode
Avalanche Rated

IXTQ 200N06P

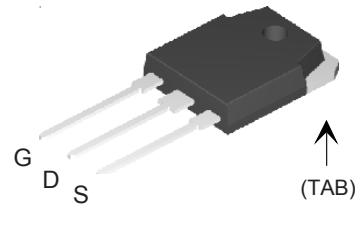
V_{DSS} = 60 V
 I_{D25} = 200 A
 $R_{DS(on)}$ ≤ 6.0 mΩ



| Symbol | Test Conditions | Maximum Ratings | | |
|---------------------|--|-----------------|--|-----------|
| V_{DSS} | T_J = 25°C to 175°C | 60 | | V |
| V_{DGR} | T_J = 25°C to 175°C; $R_{GS} = 1\text{ M}\Omega$ | 60 | | V |
| V_{GS} | Transient | ±30 | | V |
| V_{GSM} | Continuous | ±20 | | V |
| I_{D25} | $T_c = 25^\circ\text{C}$ | 200 | | A |
| $I_{D(\text{RMS})}$ | External lead current limit | 75 | | A |
| I_{DM} | $T_c = 25^\circ\text{C}$, pulse width limited by T_{JM} | 400 | | A |
| I_{AR} | $T_c = 25^\circ\text{C}$ | 60 | | A |
| E_{AR} | $T_c = 25^\circ\text{C}$ | 80 | | mJ |
| E_{AS} | $T_c = 25^\circ\text{C}$ | 4.0 | | J |
| dv/dt | $I_s \leq I_{DM}$, $\text{di/dt} \leq 100\text{ A}/\mu\text{s}$, $V_{DD} \leq V_{DSS}$, $T_J \leq 150^\circ\text{C}$, $R_G = 4\ \Omega$ | 10 | | V/ns |
| P_D | $T_c = 25^\circ\text{C}$ | 714 | | W |
| T_J | | -55 ... +175 | | °C |
| T_{JM} | | 175 | | °C |
| T_{stg} | | -55 ... +150 | | °C |
| T_L | 1.6 mm (0.062 in.) from case for 10 s | 300 | | °C |
| T_{SOLD} | Plastic body for 10 s | 260 | | °C |
| M_d | Mounting torque (TO-3P) | 1.13/10 | | Nm/lb.in. |
| Weight | TO-3P | 5.5 | | g |

| Symbol | Test Conditions ($T_J = 25^\circ\text{C}$, unless otherwise specified) | Characteristic Values | | |
|---------------------|--|---------------------------|------|------|
| | | Min. | Typ. | Max. |
| BV_{DSS} | $V_{GS} = 0\text{ V}$, $I_D = 250\text{ }\mu\text{A}$ | 60 | | V |
| $V_{GS(\text{th})}$ | $V_{DS} = V_{GS}$, $I_D = 250\text{ }\mu\text{A}$ | 2.5 | | V |
| I_{GSS} | $V_{GS} = \pm 20\text{ V}_{DC}$, $V_{DS} = 0$ | | ±100 | nA |
| I_{DSS} | $V_{DS} = V_{DSS}$ $V_{GS} = 0\text{ V}$ | $T_J = 150^\circ\text{C}$ | 25 | μA |
| | | | 250 | μA |
| $R_{DS(on)}$ | $V_{GS} = 10\text{ V}$, $I_D = 60\text{ A}$ $V_{GS} = 15\text{ V}$, $I_D = 400\text{ A}$ Pulse test, $t \leq 300\text{ }\mu\text{s}$, duty cycle $d \leq 2\%$ | 5.0 | 6.0 | mΩ |

TO-3P (IXTQ)



G = Gate
S = Source
TAB = Drain

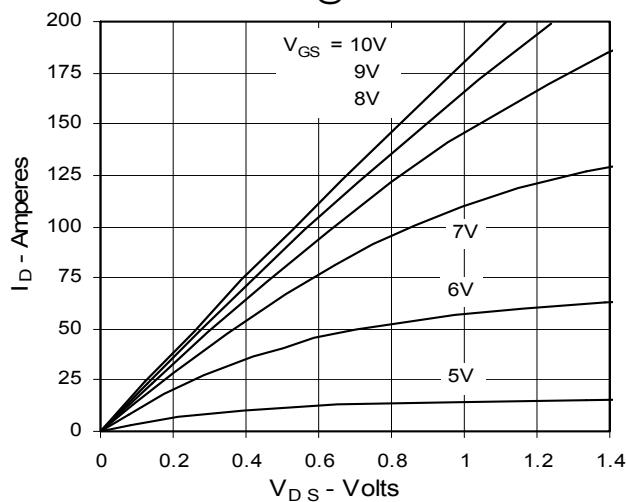
Features

- International standard package
- Unclamped Inductive Switching (UIS) rated
- Low package inductance
 - easy to drive and to protect

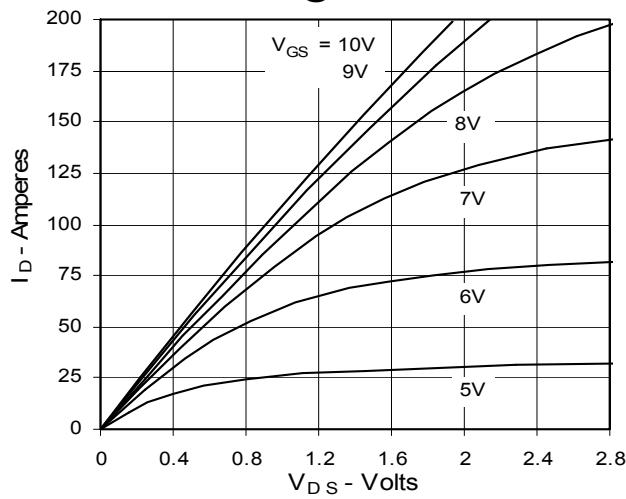
Advantages

- Easy to mount
- Space savings
- High power density

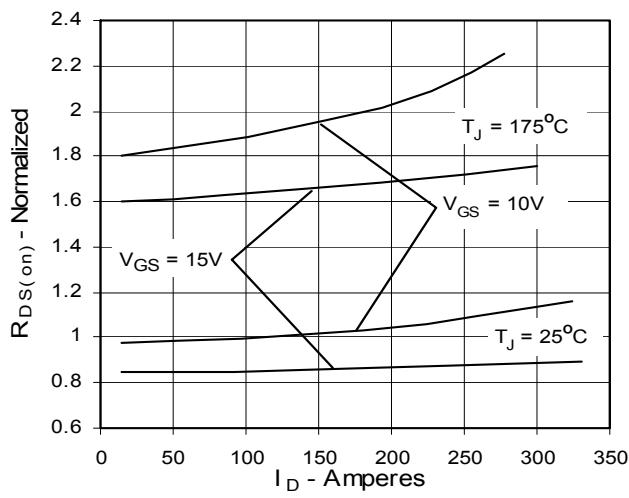
**Fig. 1. Output Characteristics
@ 25°C**



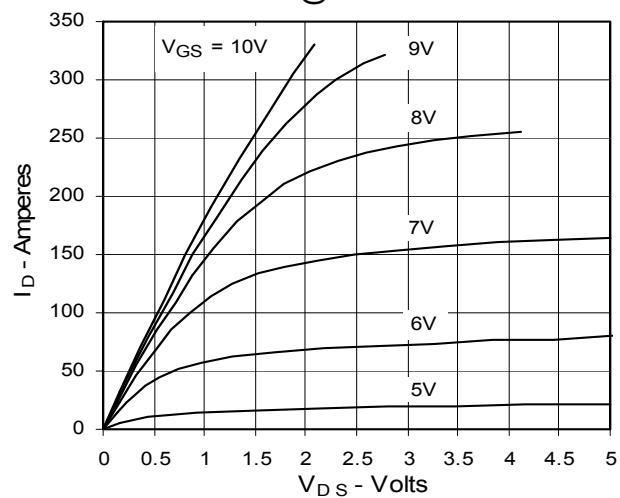
**Fig. 3. Output Characteristics
@ 150°C**



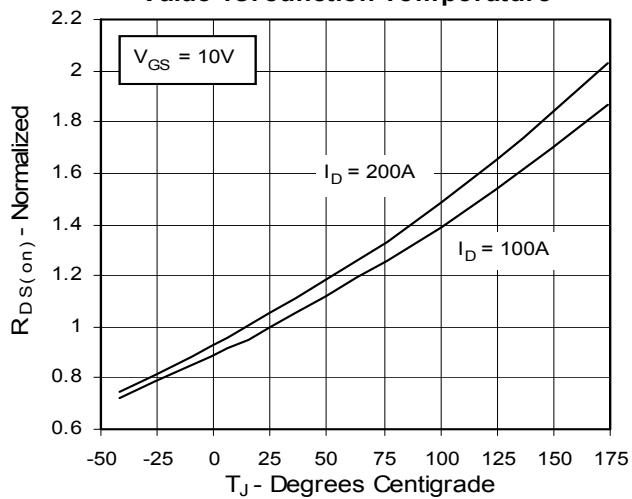
**Fig. 5. $R_{DS(on)}$ Normalized to 0.5 I_{D25}
Value vs. Drain Current**



**Fig. 2. Extended Output Characteristics
@ 25°C**



**Fig. 4. $R_{DS(on)}$ Normalized to 0.5 I_{D25}
Value vs. Junction Temperature**



**Fig. 6. Drain Current vs. Case
Temperature**

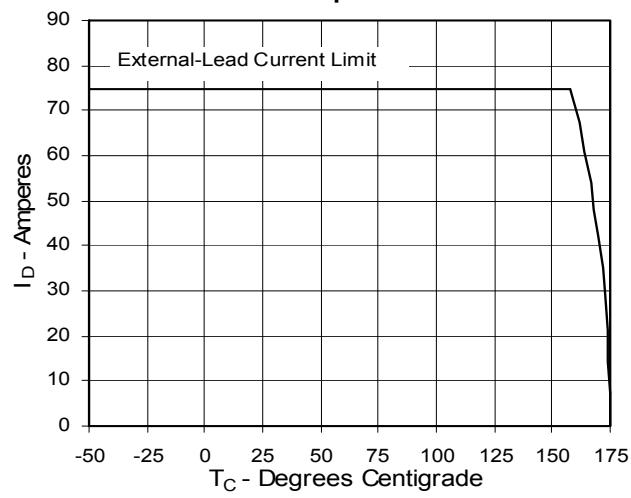


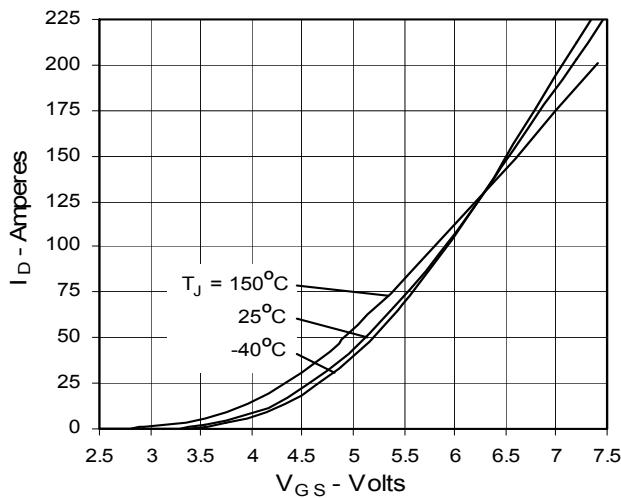
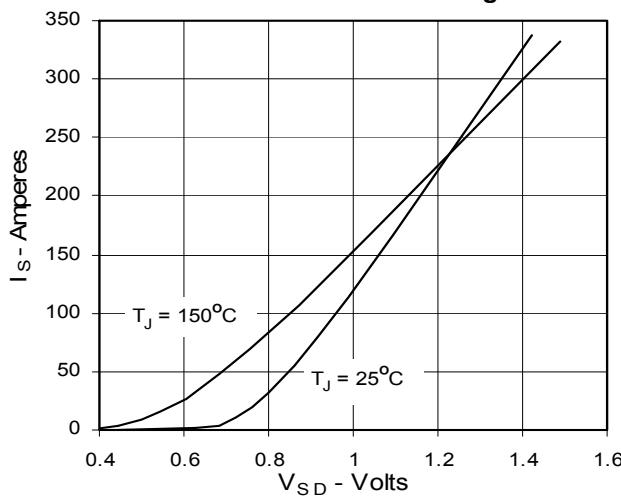
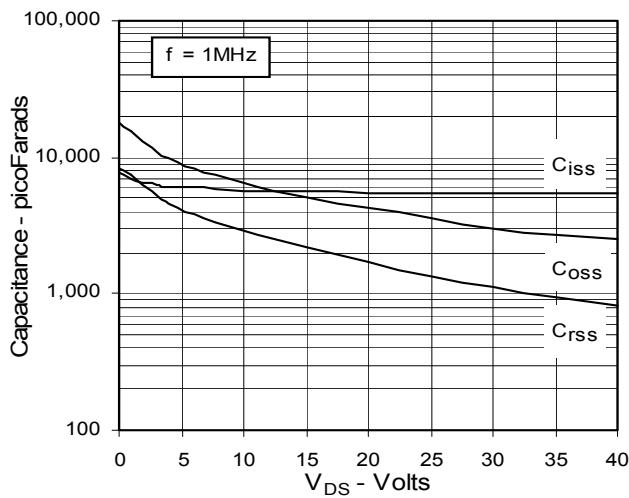
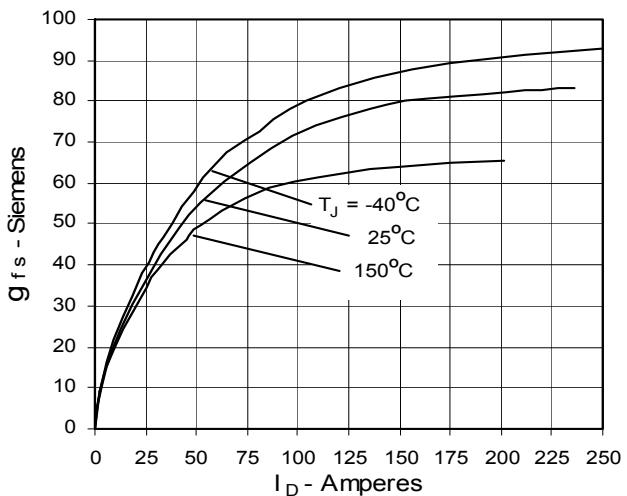
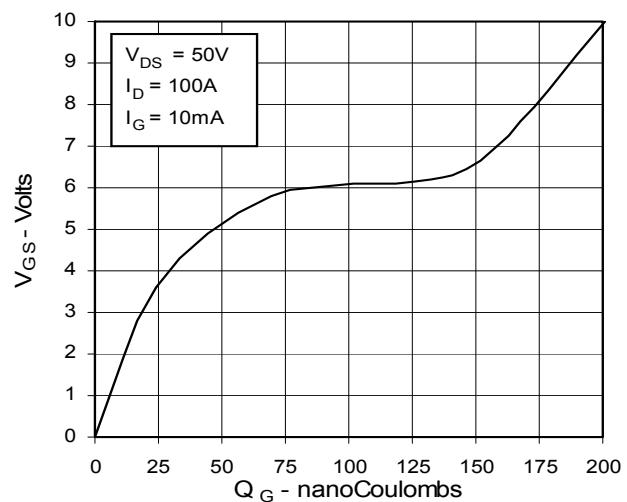
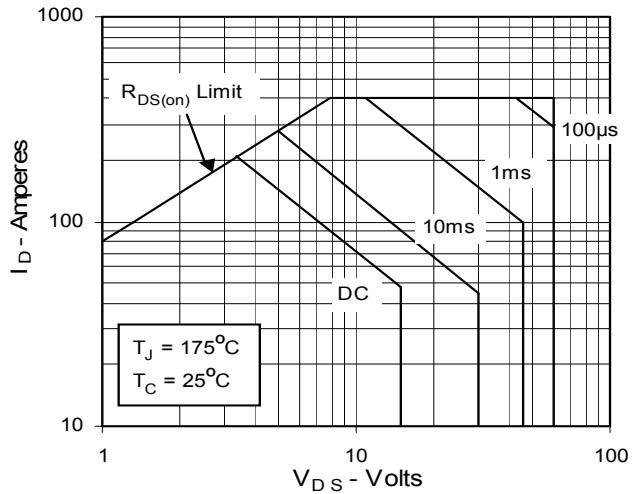
Fig. 7. Input Admittance**Fig. 9. Source Current vs. Source-To-Drain Voltage****Fig. 11. Capacitance****Fig. 8. Transconductance****Fig. 10. Gate Charge****Fig. 12. Forward-Bias Safe Operating Area**

Fig. 13. Maximum Transient Thermal Resistance